

# BGO807; BGO807/FC0; BGO807/SC0

870 MHz optical receivers

Rev. 2 — 29 September 2010

**Product data sheet** 

# 1. Product profile

### 1.1 General description

High dynamic range optical receiver amplifier modules in a standard SOT115 package where the non-jacketed fiber has either no connector or has an FC/APC or SC/APC connector.

The amplifier supply voltage pin and the photo diode bias voltage pin both connect to 24 V (DC).

The modules have a mono mode optical input suitable for 1290 nm to 1600 nm wavelengths, a terminal to monitor the photo diode current and an electrical output having a characteristic impedance of 75  $\Omega$ .

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

## **1.2 Features and benefits**

- Excellent linearity
- Low noise
- Excellent flatness
- Standard CATV outline
- Rugged construction
- Gold metallization ensures excellent reliability
- High optical input power range.

### **1.3 Applications**

• CATV optical node systems operating in the 40 MHz to 870 MHz frequency range.



870 MHz optical receivers

## 1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f	frequency range		40	-	870	MHz
S <sub>22</sub>	output return losses	f = 40  MHz to 870 MHz	11	-	-	dB
	optical input return losses		45	-	-	dB
d <sub>2</sub>	second order distortion	f = 854.5 MHz	-	-	-55	dB
F	equivalent noise input	f = 40  MHz to 870 MHz	-	-	8.5	pA/√Hz
I <sub>tot</sub>	total current consumption (DC)	V <sub>B</sub> = 24 V	175	-	205	mA

# 2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
BGO807	(SOT115T)		
1	monitor current		
2, 3	common		
4	$+V_B$ of the photodiode		
5	$+V_B$ of the amplifier		╼╧
7, 8	common		1 2, 3, 7, 8
9	output		sym098
BGO807/	FC0 (SOT115X)		
1	monitor current		
2, 3	common		
4	$+V_B$ of the photodiode		
5	$+V_B$ of the amplifier		╼╡╪┻╵
7, 8	common		1 2, 3, 7, 8
9	output		sym098
BGO807/	SC0 (SOT115Y)		
1	monitor current		
2, 3	common		
4	$+V_B$ of the photodiode		
5	$+V_B$ of the amplifier		╼╡╪┻╵
7, 8	common		1 2, 3, 7, 8
9	output		sym098

# 3. Ordering information

Table 3.Ordering information
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Type number	Package						
	Name	Description	Version				
BGO807	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input; 8 gold-plated in-line leads	SOT115T				
BGO807/FC0	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 × 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads	SOT115X				
BGO807/SC0	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads	SOT115Y				

## 4. Limiting values

### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
f	frequency range		40	870	MHz
T <sub>stg</sub>	storage temperature		-40	+85	°C
T <sub>mb</sub>	operating mounting base temperature		-20	+85	°C
P <sub>in</sub>	optical input power	continuous	-	5	mW
ESD	ESD sensitivity	human body model; R = 1.5 k $\Omega$ ; C = 100 pF	500	-	V

# 5. Characteristics

### Table 5.Characteristics

In accordance with the Absolute Maximum Rating System (IEC 60134); bandwidth 40 MHz to 870 MHz;  $V_B = 24 V$ ;  $T_{mb} = 30 \ ^{\circ}C$ ;  $Z_L = 75 \Omega$ .

me							
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
S	responsivity						
	BGO807	$\lambda = 1300 \text{ nm}$		800	-	-	V/W
	BGO807/FC0; BGO807/SC0	$\lambda = 1300 \text{ nm}$		750	-	-	V/W
FL	flatness straight line (peak to valley)	f = 40 MHz to 870 MHz		-	-	1	dB
SL	slope straight line	f = 40  MHz to 870 MHz		0	-	2	dB
S <sub>22</sub>	output return losses	f = 40  MHz to 870 MHz		11	-	-	dB
	optical input return losses			45	-	-	dB
d <sub>2</sub>	second order distortion	f <sub>m</sub> = 446.5 MHz	[1][2]	-	-	-66	dB
		f <sub>m</sub> = 746.5 MHz	[1][3]	-	-	-61	dB
		f <sub>m</sub> = 854.5 MHz	[1][4]	-	-	-55	dB
d <sub>3</sub>	third order distortion	f <sub>m</sub> = 853.25 MHz	[5][6]	-	-	-71	dB

### Table 5. Characteristics ... continued

In accordance with the Absolute Maximum Rating System (IEC 60134); bandwidth 40 MHz to 870 MHz;  $V_B = 24 V$ ;  $T_{mb} = 30 \ ^{\circ}C$ ;  $Z_L = 75 \Omega$ .

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
F	equivalent noise input	f = 40 MHz to 450 MHz	-	-	7	pA/√Hz
		f = 450 MHz to 750 MHz	-	-	8	pA/√Hz
		f = 750 MHz to 870 MHz	-	-	8.5	pA/√Hz
S <sub>λ</sub>	spectral sensitivity	$\lambda = 1310 \pm 20 \text{ nm}$	0.85	-	-	A/W
		$\lambda$ = 1550 ±20 nm	0.9	-	-	A/W
λ	optical wavelength		1290	-	1600	nm
L	length of optical fiber; SM type; 9/125 μm					
	BGO807		1	-	-	m
	BGO807/FC0; BGO807/SC0		746	-	861	mm
I <sub>tot</sub>	total current consumption (DC)		175	-	205	mA
I <sub>bias</sub>	diode bias current at pin 4 (DC)		-	-	25	mA

[1] Two laser test; each laser with a modulation index of 40%;  $P_{opt} = 1 \text{ mW}$  (total).

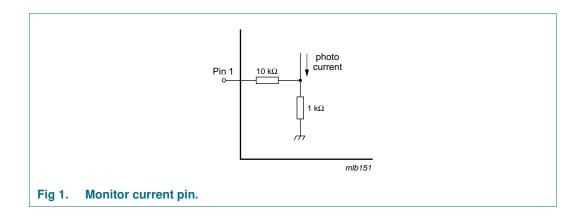
[2]  $f_m = 446.5 \text{ MHz}$ ;  $f_p = 97.25 \text{ MHz}$ ;  $f_q = 349.25 \text{ MHz}$ .

 $[3] \quad f_m = 746.5 \text{ MHz}; f_p = 133.25 \text{ MHz}; f_q = 613.25 \text{ MHz}.$ 

[4]  $f_m = 854.5 \text{ MHz}; f_p = 133.25 \text{ MHz}; f_q = 721.25 \text{ MHz}.$ 

[5] Three laser test; each laser with a modulation index of 60%; P<sub>opt</sub> = 1 mW (total).

[6]  $f_m = 853.25 \text{ MHz}$ ;  $f_p = 133.25 \text{ MHz}$ ;  $f_q = 265.25 \text{ MHz}$ ;  $f_r = 721.25 \text{ MHz}$ .

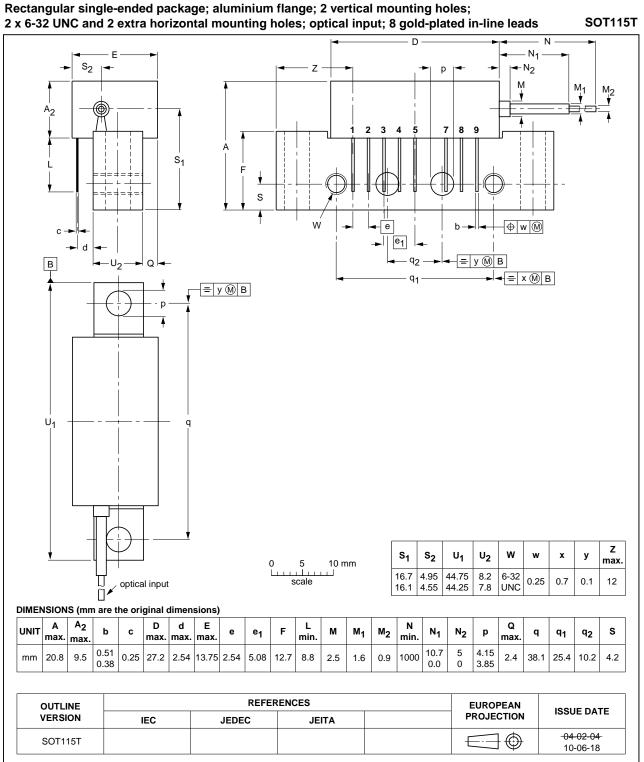


### **NXP Semiconductors**

# BG0807/BG0807/FC0/SC0

870 MHz optical receivers

### **Package outline** 6.



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BGO807 FC0 SC0

Package outline SOT115T. Fig 2.

# BG0807/BG0807/FC0/SC0

870 MHz optical receivers

**SOT115X** 

#### Е D N<sub>1</sub> s<sub>2</sub> Ζ р $N_2$ М M<sub>1</sub> ¥ A<sub>2</sub> 2 7 8 9 3 4 S<sub>1</sub> Т s 4 с 🔶 w 0 w 🕅 е h 🗕 d e<sub>1</sub> Q U2 В ← = y M B q2 = y 🕅 B ◄ = x (M) B q1 р N R Uı q 25 mm Scale connector 10 mm z 5 0 s<sub>1</sub> s<sub>2</sub> s w U1 U2 w х У тŤт max Т scale 16.7 4.95 44.75 8.2 6-32 4.2 Ũ 0.25 0.7 0.1 12 16.1 4.55 44.25 7.8 UNC DIMENSIONS (mm are the original dimensions) D Е R Α A2 d L Q M<sub>2</sub> UNIT F b с Μ Μ1 е e<sub>1</sub> Ν N<sub>1</sub> N<sub>2</sub> р q q1 q2 max. max max. max. max min. max min. 0.51 861 10.7 5 4.15 20.8 9.5 0.25 27.2 2.54 13.75 2.54 5.08 8.8 2.5 0.9 2.4 38.1 25.4 10.2 35 mm 12.7 1.6 0.38 746 0.0 0 3.85 REFERENCES EUROPEAN OUTLINE ISSUE DATE VERSION IEC PROJECTION JEDEC JEITA 04-02-04

### Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

10-06-18

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SOT115X

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**Product data sheet** 

Package outline SOT115X. Fig 3.

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**SOT115Y** 

### Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

Е D N<sub>1</sub> s<sub>2</sub> Ζ р  $N_2$ М M<sub>1</sub>  $M_2$ ¥ A<sub>2</sub> 2 7 8 9 3 4 S<sub>1</sub> Т s 4 с 🔶 ۱۸/ 0 w е h 🗕 d e<sub>1</sub>  $U_2$ Q В - = y M B q2 = y 🕅 B q1 р R Uı q 0 25 mm Scale connector z 10 mm 5 0 s s<sub>1</sub> S<sub>2</sub> U1 U2 w w х У max i È i L Π scale 6-32 UNC 16.7 4.95 44.75 8.2 4.2 0.25 0.7 0.1 12 Ũ 7.8 4.55 44.25 16.1 DIMENSIONS (mm are the original dimensions) D Е R Α A2 d L Q M<sub>2</sub> UNI F М<sub>1</sub> N<sub>1</sub> b с е М Ν N<sub>2</sub> e<sub>1</sub> р q q1 q2 max. max max. max. max min. max min. 0.51 861 10.7 5 4.15 20.8 9.5 0.25 27.2 2.54 13.75 2.54 5.08 12.7 8.8 2.5 1.6 0.9 2.4 38.1 25.4 10.2 35 mm 0.38 746 0.0 0 3.85 REFERENCES EUROPEAN OUTLINE ISSUE DATE VERSION IEC JEDEC PROJECTION JEITA 04-02-05  $\odot$ SOT115Y **—** 10-06-18

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Fig 4. Package outline SOT115Y.

# 7. Handling information

Fiberglass optical coupling: maximum tensile strength = 5 N; minimum bending radius = 35 mm.

## 8. Revision history

Table 6. Revision histor	ry			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BGO807_FC0_SC0 v.2	20100929	Product data sheet	-	BGO807_FC0_SC0 v.1
Modifications:		of this data sheet has bee NXP Semiconductors.	n redesigned to comply	y with the new identity
	<ul> <li>Legal texts h</li> </ul>	ave been adapted to the	new company name w	here appropriate.
	<ul> <li>Pinning infor</li> </ul>	mation: presentation was	modified, graphic sym	bols were added.
	<ul> <li>Package out</li> </ul>	line and simplified outline	drawings have been u	updated to the latest version.
BGO807_FC0_SC0 v.1 (9397 750 13192)	20040707	Product data sheet	-	-

## 9. Legal information

### 9.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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